

MAX15093/MAX15093A Evaluation Kits

Evaluate: MAX15093/MAX15093A

General Description

The MAX15093/MAX15093A evaluation kits (EV kits) provide a proven design to evaluate the MAX15093/MAX15093A hot-swap controllers with an integrated 15A MOSFET. The EV kits are configured to pass 15A in a 2.7V to 18V hot-swap application, thus providing a fully integrated solution. The EV kits use the MAX15093GWL+/MAX15093AGWL+T in a 2.57mm x 4.03mm, 40-bump, 0.5mm pitch wafer-level package (WLP) with a proven four-layer PCB design. As configured, the EV kits are optimized to operate at 12V.

The two EV kit versions (MAX15093AEVKIT# and MAX15093EVKIT#) are built on the same PCB fabrication and can be used interchangeably to evaluate either the MAX15093 or MAX15093A by replacing U1 with the desired device.

Features

- 2.7V to 18V Operating-Voltage Range
- Up to 15A Configurable Load-Current Capability
- Banana Jacks for Input and Output Voltage
- Programmable Slew-Rate Control
- Selectable/Configurable Circuit-Breaker Threshold
- Configurable Overvoltage/Undervoltage Lockout
- Programmable Timeout Delay
- FAULT and PG Outputs
- Defined Safe Operation Area
- Proven PCB Layout
- Fully Assembled and Tested

Quick Start

Required Equipment

- MAX15093 or MAX15093A EV kit
- 12V, 15A DC power supply
- Voltmeter

Procedure

The EV kits are fully assembled and tested. Follow the steps below to verify board operation. **Caution: Do not turn on the power supply until all connections are completed.**

- 1) Verify that a shunt is installed across pins 1-2 on the following jumpers: J1, J3, J4, J5, UV_IN, and CB.
- 2) Turn on the power supply and set the supply to 12V, then disable the power supply.
- 3) Connect the positive terminal of the power supply to the IN banana jack on the EV kits. Connect the negative terminal of the power supply to the GND banana jack.
- 4) Enable the power supply.
- 5) Verify that the voltage between the OUT and GND banana jacks is 12V.
- 6) Verify that the internal regulator voltage (REG) is 3.3V.
- 7) The EV kits are now ready for additional evaluation.

[Ordering Information](#) appears at end of data sheet.

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Detailed Description of Hardware

The MAX15093 EV kit provides a proven design to evaluate the MAX15093. The MAX15093 EV kit can be conveniently connected between the system power and the load using the banana jacks provided for the input and output. PCB pads are provided to monitor and control the device signals. The MAX15093 EV kit operates between 2.7V and 18V up to 15A load current capability.

Evaluating the MAX15093 or MAX15093A

The MAX15093 EV kit can be used to evaluate the MAX15093A with the MAX15093AGWL+T installed, while the MAX15093A EV kit can be used to evaluate the MAX15093 with the MAX15093GWL+ installed. The MAX15093A is pin-to-pin compatible with the MAX15093. Refer to the MAX15093/MAX15093A IC data sheet for details on the MAX15093A.

Circuit Breaker (CB)

Jumper CB sets the current limit for the internal circuit breaker (CB) of the device. The CB pin can be connected to a fixed resistor (R5) or a potentiometer (R11) to set the current limit. See [Table 1](#) for shunt positions.

The circuit-breaker threshold can be set according to the following formula:

$$I_{CB} = R_{CB}/2227 - 1.05$$

where I_{CB} is in A and R_{CB} (the resistor between CB and ground) is in Ω .

Setting Timeout Delay for TIMEOUT (CDLY)

Capacitor C4 is used to set the timeout delay for TIMEOUT to go low to prevent internal MOSFET shutdown after power-up. This is set at a rate of 1s/ μ F. The EV kit is configured for a 47ms timeout delay.

Delayed TIMEOUT

The IC's TIMEOUT pin must be pulled low before the timeout delay set by capacitor C4 elapses. The EV kit provides a simple timer circuit comprised of U2, R7, and C5 to pull the TIMEOUT pin low before the timeout delay. Once PG asserts as open-drain, R7 begins to charge C5 to the output voltage (OUT). When C5 charges to 2/3 x

OUT, U2 pulls the TIMEOUT pin low. The EV kit is configured to have TIMEOUT pulled low after ~22ms.

Jumper TIMEOUT is also provided to bypass the timeout delay and force TIMEOUT low, if installed. See [Table 2](#) for TIMEOUT settings.

Setting the Output Slew Rate

An external capacitor (C3) is connected from GATE to GND on the IC to reduce the output slew rate during startup. During startup, a 5.7 μ A (typ) current is sourced to enhance the internal MOSFET with 28V/ms (typ). C3 can be calculated according to the following formula:

$$C_3 = I_{GATE} \times (t_{ON}/V_{OUT})$$

where I_{GATE} is 5.7 μ A (typ), t_{ON} is the desired output ramp-up time, and V_{OUT} is assumed to start from zero.

Undervoltage Lockout

The EV kit provides an option to configure the undervoltage-lockout threshold. The undervoltage-lockout threshold for the device is configured by the IN voltage level divided by R1 and (R2 + R3) at the UV pin. By default, the undervoltage-lockout threshold is set to 10.8V. The EV kit also provides an option to externally provide a UV threshold. Remove the jumper for UV_IN, then connect a power supply with the desired voltage to the UV pin. Remove R2 to make UV independent from OV.

Oversupply Lockout

The EV kits provide an option to configure the oversupply-lockout threshold. The oversupply-lockout threshold for the device is configured by the IN voltage level divided by (R1 + R2) and R3 at the OV pin. By default, the oversupply-lockout threshold is set to 14V. The EV kit also provides an option to externally provide an OV threshold. Remove the jumper for UV_IN, then connect a power supply with the desired voltage to the OV pin. Remove R2 to make OV independent from UV.

Current-Sense Output (ISENSE)

The IC's ISENSE pin is the output of an accurate current-sense amplifier and provides a source current proportional to the load current flowing into the main switch. The factory-trimmed current ratio is set to 157 μ A/A. On the EV kit, this allows producing a scaled voltage by routing resistor R6 from ISENSE to GND.

Table 1. CB Jumper Selection

SHUNT POSITION	CB PIN CONNECTED TO	CURRENT LIMIT
1-2*	R5	16.5A
2-3	R11	Adjustable

*Default position.

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Table 2. TIMEOUT Jumper Selection

SHUNT POSITION	EN PIN	TIMEOUT DELAY
Installed	Forced to GND	Bypassed
Not installed*	Set low when C5 is charged to 2/3 x OUT; timing is set by R7/C5	47ms (set by C4)

*Default position.

Component Suppliers

SUPPLIER	PHONE	WEBSITE
Fairchild Semiconductor	888-522-5372	www.fairchildsemi.com
Murata Americas	770-436-1300	www.murataamericas.com
TDK Corp.	847-803-6100	www.component.tdk.com

Note: Indicate that you are using the MAX15093/MAX15093A when contacting these component suppliers.

Ordering Information

PART	TYPE	DESCRIPTION
MAX15093EVKIT#	EV Kit	Latched-off fault management
MAX15093AEVKIT#	EV Kit	Auto-retry fault management

#Denotes RoHS compliant.

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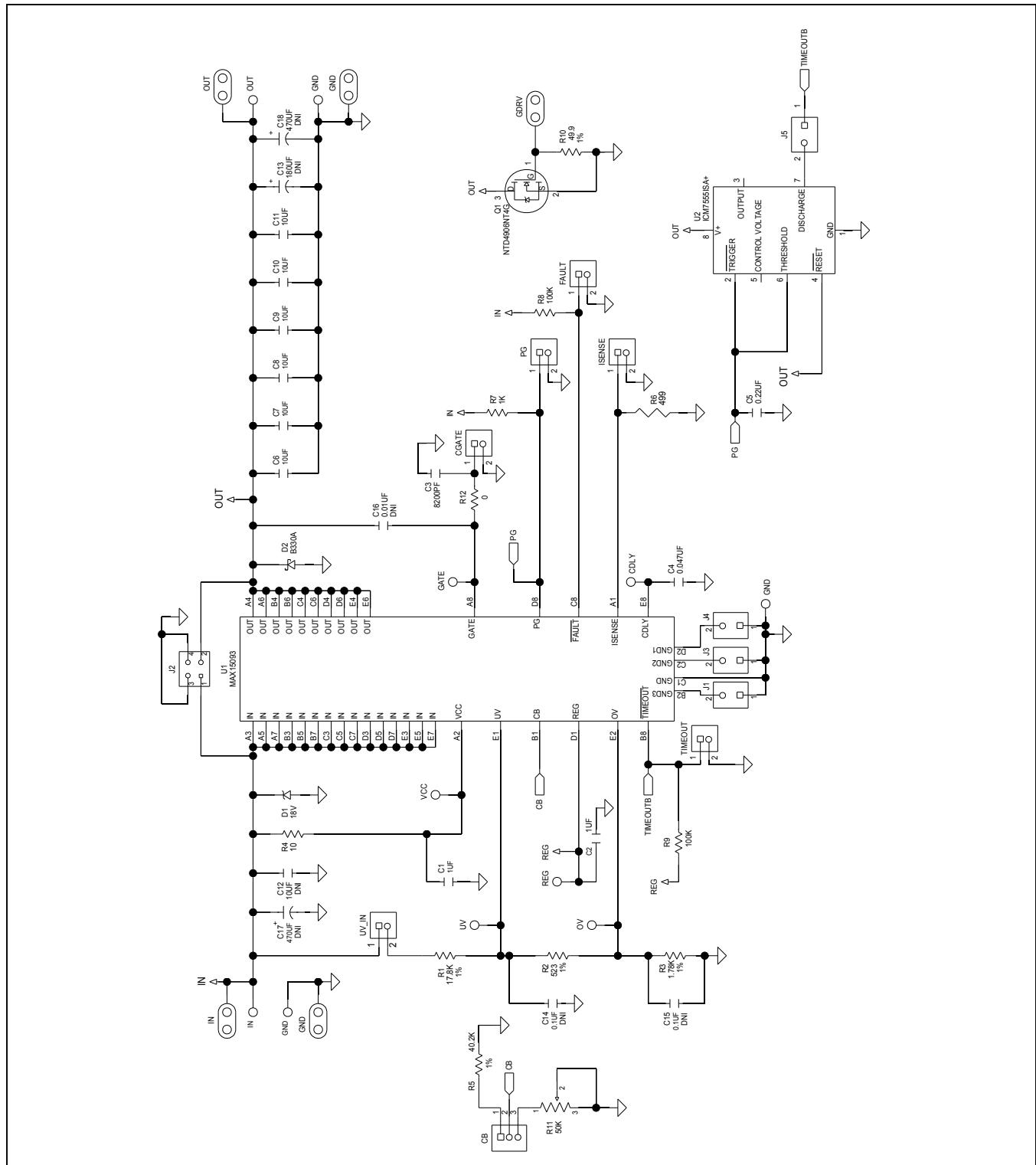
MAX15093/93A EV Component List

TITLE: Bill of Materials DESIGN: max15093_evkit_a								
ITEM	QTY	REF DES	Var Status	MAXINV	MFG PART #	MANUFACTURER	VALUE	DESCRIPTION
1	2	C1, C2	Pref	20-0001U-251	C1005X5R1E105K050	TDK	1UF	CAPACITOR; SMT (0402); CERAMIC CHIP; 1UF; 25V; TOL=10%; TG=-55DEGC TO +85 DEGC; TC=X5R
2	1	C3	Pref	20-8200P-14	C0402X7R500822KNP	VENKEL LTD.	8200PF	CAPACITOR; SMT; 0402; CERAMIC; 8200pF; 50V; 10%; X7R; -55degC to +125degC; +/-15% degC MAX.
3	1	C4	Pref	20-0047-03	C1005X7R1E1473K; GRM155R71E1473K C0603C224K3RA; GMC10X7R224K25;	TDK/MURATA	0.047UF	CAPACITOR; SMT (0402); CERAMIC CHIP; 0.047UF; 25V; TOL=10%; TG=-55DEGC TO +125 DEGC; TC=X7R
4	1	C5	Pref	20-00U22-12	GRM188R71E224KA8; C1608X7R1E224K08	KEMET; MURATA; TDK	0.22UF	CAPACITOR; SMT (1206); CERAMIC CHIP; 0.22UF; 25V; TOL=10%; TG=-55DEGC TO +125 DEGC; TC=X7R
5	6	C6-C11	Pref	20-0010U-A4	GRM31CR71E106KA12L; CL31B106KAHNNN	MURATA; SAMSUNG ELECTRONICS	10UF	CAPACITOR; SMT (1206); CERAMIC CHIP; 10UF; 25V; TOL=10%; TG=-55DEGC TO +125 DEGC; TC=X7R
6	1	CB	Pref	01-PEC03SAAN3P-21	PEC03SAAN	SULLINS	PEC03SAAN	CONNECTOR; MALE; THROUGH HOLE; BREAKAWAY; STRAIGHT; 3PINS
		OV, UV, REG, VCC, CDLY,						TEST POINT; PIN DIA=0.1IN; TOTAL LENGTH=0.3IN; BOARD HOLE=0.04IN; RED; PHOSPHOR BRONZE WIRE SILVER PLATE FINISH; RECOMMENDED FOR BOARD THICKNESS=0.062IN; NOT FOR COLD TEST
7	6	GATE	Pref	02-TPMINI5000-00		5000 KEYSTONE	N/A	
		J1, J3-J5, PG, CGATE, FAULT, UV_IN, SENSE,						
8	10	TIMEOUT	Pref	01-PEC02SAAAN2P-21	PEC02SAAAN	SULLINS	PEC02SAAAN	CONNECTOR; MALE; THROUGH HOLE; BREAKAWAY; STRAIGHT; 2PINS
9	1	D1	Pref	30-SMB18A-00	SMB18A	LITTLE FUSE	18V	DIODE; TVS; SMB (DO-214AA); PIV=18V; IF=20.6A
10	1	D2	Pref	30-B330A-00	B330A	DIODES INCORPORATED	B330A	DIODE; SCH; SMT; PIV=30V; IF=3A
		INX, GDRV, OUTX, GNDX1,						
11	5	GNDX2	Pref	01-9020BUSS20AWG-00	9020 BUSS	WEICO WIRE	MAXIMPAD	EVK KIT PARTS: MAXIM PAD; WIRE; NATURAL; SOLID; WEICO WIRE; SOFT DRAWN BUS TYPE-S; 20AWG
12	2	GND, GND1	Pref	01-70071P-80		7007 KEYSTONE	7007 BLACK	CONNECTOR; PANELMOUNT; BINDING POST; STRAIGHT THROUGH; 1PIN;
13	2	IN, OUT	Pref	01-70061P-80		7006 KEYSTONE	7006 RED	CONNECTOR; PANELMOUNT; BINDING POST; STRAIGHT THROUGH; 1PIN;
14	1	J2	Pref	01-PEC02DAAN4P-21	PEC02DAAN	SULLINS ELECTRONIC CORP.	PEC02DAAN	CONNECTOR; MALE; THROUGH HOLE; BREAKAWAY; STRAIGHT; 4PINS
15	1	Q1	Pref	90-NTD4906NT4G-21	NTD4906NT4G	ON SEMICONDUCTOR	NTD4906NT4G	TRAN; POWER MOSFET; SINGLE N-CHANNEL; NCH; TO-252; PD-(1.38W); I-(54A); V-30V
16	1	R1	Pref	80-017K8-23	CRCW040217K8FK	VISHAY DALE	17.8K	RESISTOR; 0402; 17.8K OHM; 1%; 100PPM; 0.063W; THICK FILM
17	1	R2	Pref	80-0523R-23	ERJ-2RKF5230X	VISHAY DALE/PANASONIC		RESISTOR; 0402; 523 OHM; 1%; 100PPM; 0.063W; THICK FILM 3-LAYER
18	1	R3	Pref	80-01K78-23	ERJ-2RKF1781X	PANASONIC	1.78K	523 ELECTRODE
19	1	R4	Pref	80-0010R-49	CRCW060340K2RJN	VISHAY DALE		RESISTOR; 0402; 1.78K OHM; 1%; 100PPM; 0.10W; THICK FILM
								10 RESISTOR; 0402; 10 OHM; 5%; 200PPM; 0.063W; THICK FILM
20	1	R5	Pref	80-040K2-24	3EKF4022V	VISHAY DALE/YAGEO/PANASONIC	40.2K	RESISTOR; 0603; 40.2K; 1%; 100PPM; 0.10W; THICK FILM
21	1	R6	Pref	80-0499R-23	CRCW0402499RFX / ERJ-2RKF4990X	VISHAY DALE / Panasonic		499 RESISTOR; 0402; 1K; 100PPM; 0.0625W; THICK FILM
22	1	R7	Pref	80-0001K-53	ERJ-3GEY1102V	PANASONIC	1K	RESISTOR; 0603; 1K OHM; 5%; 200PPM; 0.10W; THICK FILM
23	1	R8	Pref	80-0100K-53	ERJ-3GEY1104V	PANASONIC	100K	RESISTOR; 0603; 100K OHM; 5%; 200PPM; 0.10W; THICK FILM
24	1	R9	Pref	80-0100K-Q6	ERJ-2GEJ104X	PANASONIC	100K	RESISTOR; 0402; 100K OHM; 5%; 200PPM; 0.10W; THICK FILM
25	1	R10	Pref	80-049R-24	CRCW060349R9FK	VISHAY DALE		49.9 RESISTOR; 0603; 49.9 OHM; 1%; 100PPM; 0.10W; THICK FILM
								RESISTOR; THROUGH-HOLE-RADIAL LEAD; 3296 SERIES; 50K OHM; 10%; 100PPM; 0.5W
26	1	R11	Pref	80-0050K-AA19	3296Y-1-503LF	BOURNS	50K	0 RESISTOR; 0402; 0 OHM; 0%; JUMPER; 0.10W; THICK FILM
27	1	R12	Pref	80-0000R-26A	ERJ-2GEOR00X	PANASONIC		TEST POINT; JUMPER; STR; TOTAL LENGTH=0.24IN; BLACK; INSULATION=PBT; PHOSPHOR BRONZE CONTACT=GOLD PLATED
								EVKIT PART - IC; MAX15093; WLP20; PKG CODE W402B3+1
28	6	SU1-SU6	Pref	02-JMPFS1100B-00	SX1100-B	KYCON	SX1100-B	IC; TIM; GENERAL PURPOSE TIMER; NSOIC8 150MIL
29	1	U1	Pref	MAX15093	MAX15093	MAXIM	MAX15093	PCB: MAX15093
30	1	U2	Pref	ICM7555ISA+	ICM7555ISA+	MAXIM	ICM7555ISA+	
31	1		Pref	EPCB15093	MAX15093	MAXIM	PCB	
TOTAL	62							
DO NOT PURCHASE(DNP)								
ITEM	QTY	REF DES	Var Status	MAXINV	MFG PART #	MANUFACTURER	VALUE	DESCRIPTION
1	1	C12	DNP	20-0010U-P7	C1608X5R1E106M080AC; CL10A106MA8RNRC	TDK/SAMSUNG ELECTRONICS	10UF	CAPACITOR; SMT (0603); CERAMIC CHIP; 10UF; 25V; TOL=20%; TG=-55DEGC TO +85 DEGC; TC=X5R
2	1	C13	DNP	20-0180U-57	25SEPF180M	PANASONIC	180UF	CAPACITOR; THROUGH HOLE-RADIAL LEAD; ALUMINUM-ELECTROLYTIC; 180UF; 25V; TOL=20%
3	2	C14, C15	DNP	20-000U1-B68	GRM155R71E104KE14	MURATA	0.1UF	CAPACITOR; SMT (0402); CERAMIC CHIP; 0.1UF; 25V; TOL=10%; MODEL=GRM SERIES; TG=-55 DEGC TO +125 DEGC; TC=X7R
4	1	C16	DNP	20-00U01-B60	C0402C103K5RAC; GRM155R71H103KA88	KEMET/MURATA	0.01UF	CAPACITOR; SMT (0402); CERAMIC CHIP; 0.01UF; 25V; TOL=10%; TG=-55DEGC TO +125 DEGC; TC=X7R
5	2	C17, C18	DNP	20-0470U-39	ECA-1EM471	PANASONIC	470UF	CAPACITOR; THROUGH HOLE-RADIAL LEAD; ALUMINUM-ELECTROLYTIC; 470UF; 25V; TOL=20%
TOTAL	7							
PACKOUT (These are purchased parts but not assembled on PCB and will be shipped with PCB)								
ITEM	QTY	REF DES	MAXINV	MFG PART #	MANUFACTURER	VALUE	DESCRIPTION	COMMENTS
1	1	PACKOUT	88-00711-SML	88-00711-SML	N/A	?	BOX; SMALL BROWN 9 3/16X7X1 1/4 - PACKOUT ESD BAG; STATIC SHIELD ZIP 4inX6in/W/ESD LOGO -	
2	1	PACKOUT	87-02162-00	87-02162-00	N/A	?	PINK FOAM; FOAM; ANTI-STATIC PE 12inX12inX5MM -	
3	1	PACKOUT	85-MAXKIT-PNK	85-MAXKIT-PNK	N/A	?	PACKOUT	
4	1	PACKOUT	EVINSERT	EVINSERT	N/A	?	WEB INSTRUCTIONS FOR MAXIM DATA SHEET	
5	1	PACKOUT	85-84003-006	85-84003-006	N/A	?	LABEL (EV KIT BOX) -	
TOTAL	5						PACKOUT	

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MAX15093/93A EV Schematic



MAX15093/MAX15093A Evaluation Kits

Evaluate: MAX15093/MAX15093A

MAX15093/93A EV PCB Layout

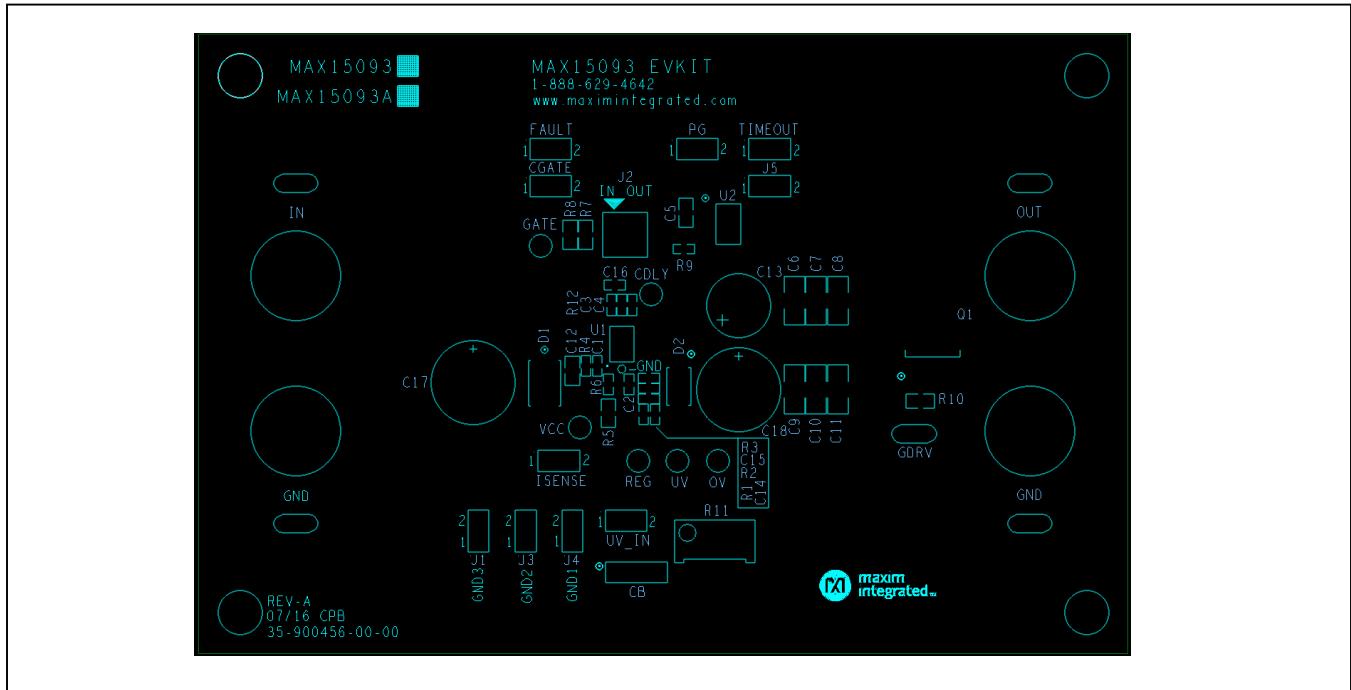


Figure 1. Component Placement Guide (Component Side)

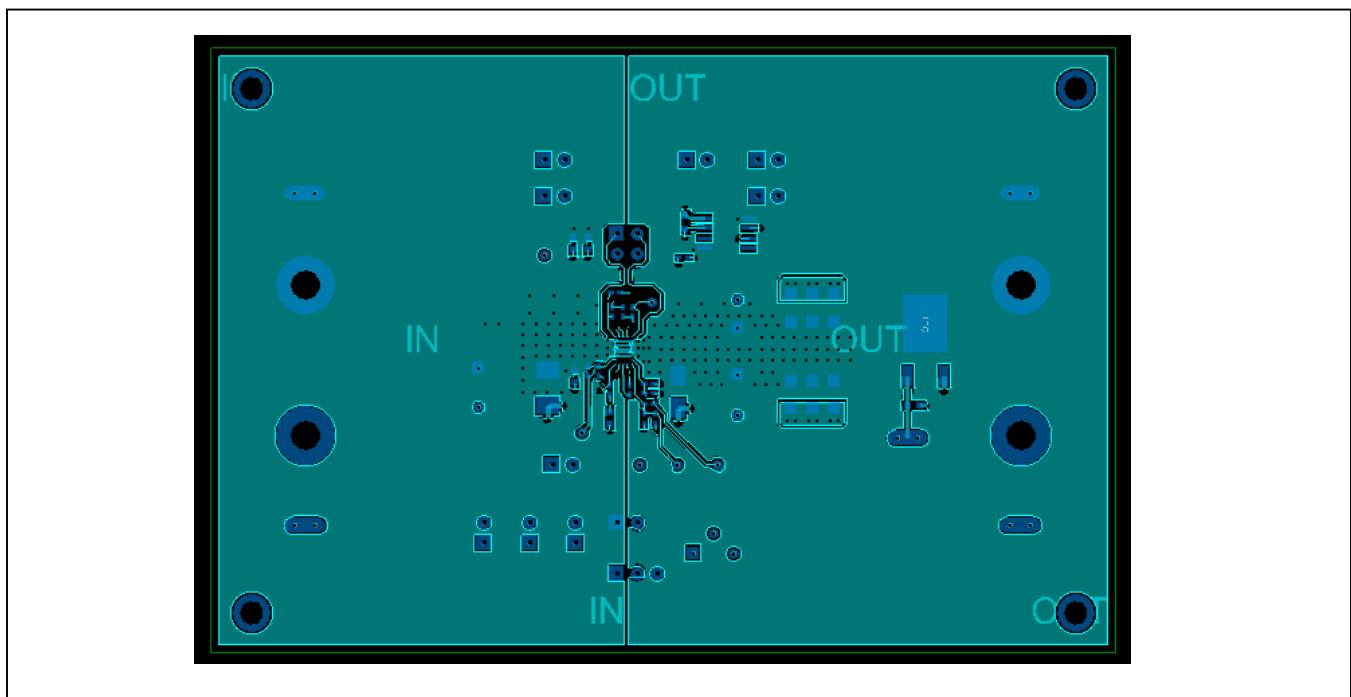


Figure 2. PCB Layout (Component Side)

MAX15093/93A EV PCB Layout (continued)

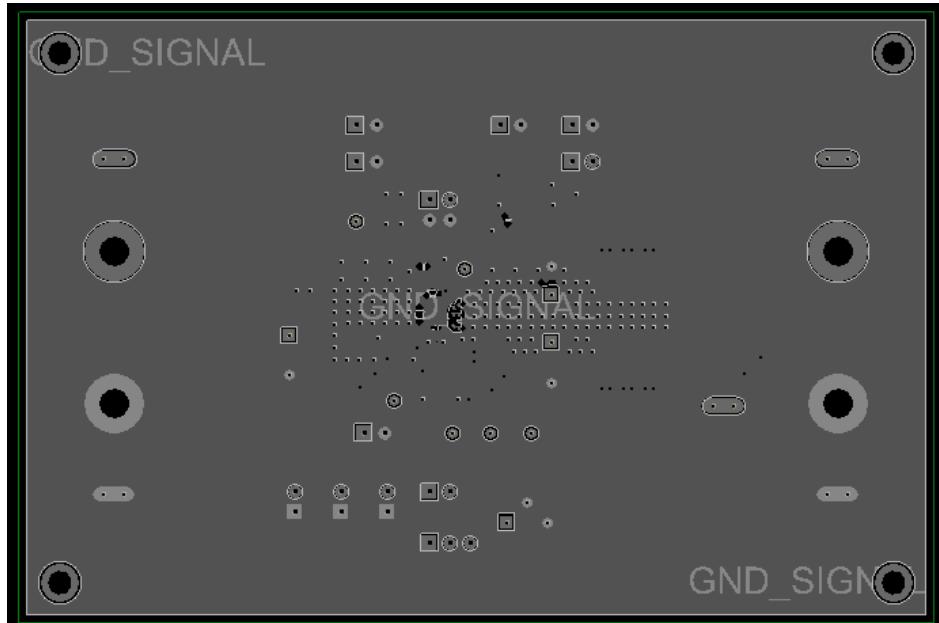


Figure 3. PCB Layout (Layer 2 (GND))

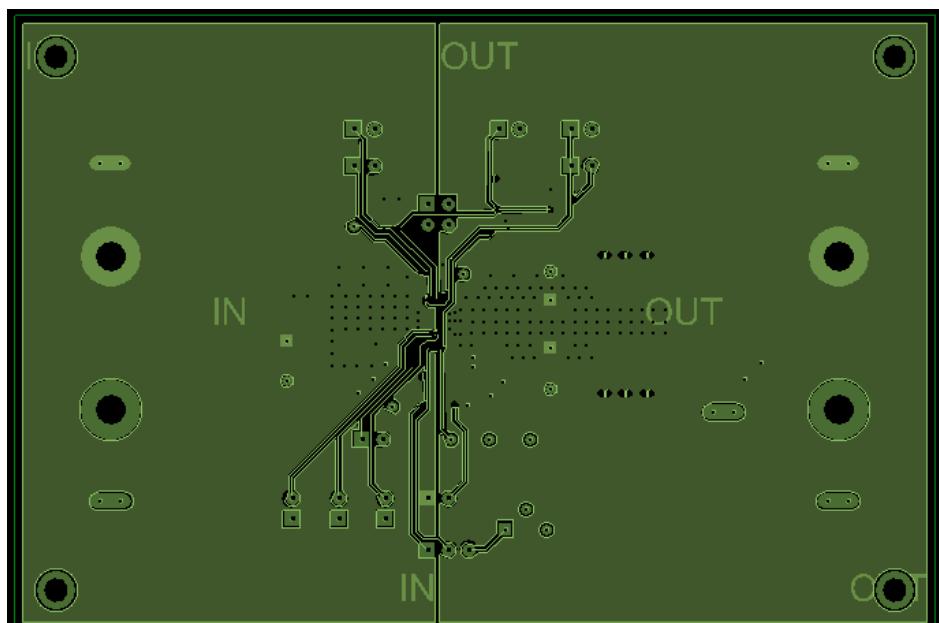


Figure 4. PCB Layout (Layer 3 (PWR))

MAX15093/93A EV PCB Layout (continued)

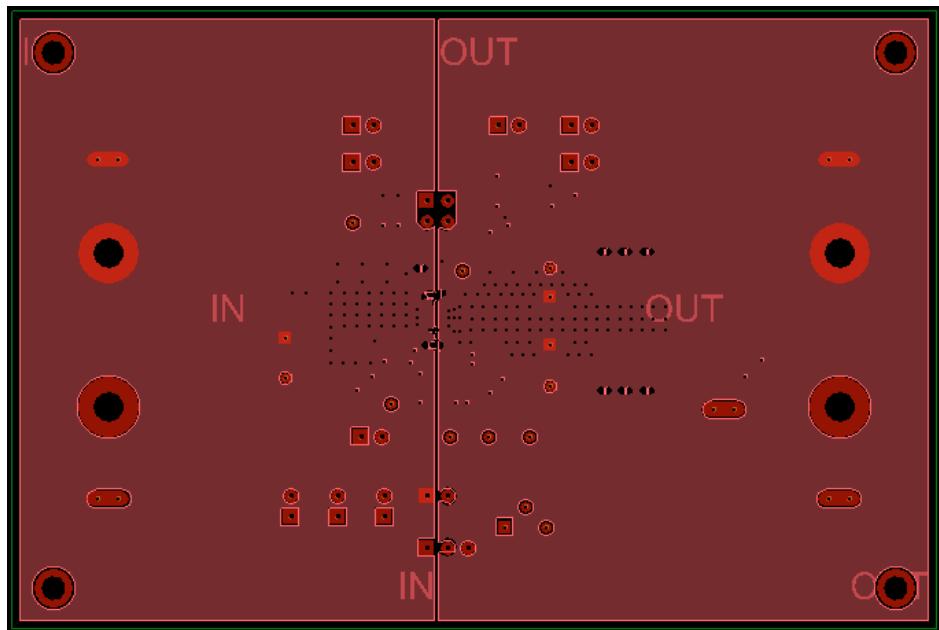


Figure 5. PCB Layout (Solder Side)

MAX15093/MAX15093A Evaluation Kits

Evaluate: MAX15093/MAX15093A

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	1/17	Initial release	—
1	7/19	Describe interchangeability of the two EV kit versions to evaluate either MAX15093 or MAX15093A	1, 2, 3

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